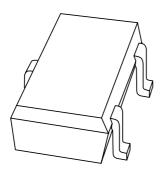
DISCRETE SEMICONDUCTORS

DATA SHEET



PMSS3906 PNP switching transistor

Product data sheet Supersedes data of 1999 Apr 22 2004 Jan 09



PNP switching transistor

PMSS3906

FEATURES

• Low current (max. 100 mA)

• Low voltage (max. 40 V).

APPLICATIONS

• Switching, e.g. telephony and professional communication equipment.

QUICK REFERENCE DATA

SYMBOL	PARAMETER	TYP.	MAX.	UNIT
V _{CEO}	collector-emitter voltage	_	-40	V
I _C	collector current	_	-100	mA
h _{FE}	DC current gain	100	300	

DESCRIPTION

PNP switching transistor in an SOT323 (SC-70) plastic package. NPN complement: PMSS3904.

PRODUCT OVERVIEW

TYPE NUMBER	PAC	KAGE	MARKING CODE(1)	NPN COMPLEMENT
TIPE NUMBER	PHILIPS	EIAJ	MARKING CODE	NPN COMPLEMENT
PMSS3906	SOT323	SC-70	06*	PMSS3904

Note

- 1. * = p: Made in Hong Kong.
 - * = t: Made in Malaysia.
 - * = W: Made in China.

SIMPLIFIED OUTLINE, SYMBOL AND PINNING

TYPE NUMBER	ER SIMPLIFIED OUTLINE AND SYMBOL		PINNING		
I TPE NUMBER			DESCRIPTION		
PMSS3906	□ 3	1	base		
	3	2	emitter		
	Top view MAM048	3	collector		

PNP switching transistor

PMSS3906

ORDERING INFORMATION

TYPE NUMBER	PACKAGE			
ITPE NUMBER	NAME	DESCRIPTION	VERSION	
PMSS3906	_	plastic surface mounted package; 3 leads	SOT323	

LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V _{CBO}	collector-base voltage	open emitter	_	-40	V
V _{CEO}	collector-emitter voltage	open base	-	-40	٧
V_{EBO}	emitter-base voltage	open collector	_	-5	٧
I _C	collector current (DC)		_	-100	mA
I _{CM}	peak collector current		-	-200	mA
I _{BM}	peak base current		_	-100	mA
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C; notes 1 and 2	_	200	mW
T _{stg}	storage temperature		-65	+150	°C
Tj	junction temperature		_	150	°C
T _{amb}	operating ambient temperature		-65	+150	°C

Notes

- 1. Refer to standard mounting conditions.
- 2. Transistor mounted on an FR4 printed-circuit board, single-sided copper, tinplated, standard footprint.

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R _{th(j-a)}	thermal resistance from junction to ambient	notes 1 and 2	625	K/W

Notes

- 1. Refer to standard mounting conditions.
- 2. Transistor mounted on an FR4 printed-circuit board, single-sided copper, tinplated, standard footprint.

PNP switching transistor

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CHARACTERISTICS

 T_{amb} = 25 °C unless otherwise specified.

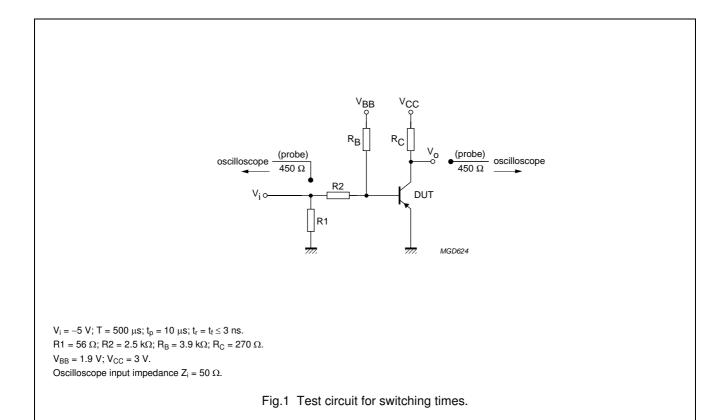
SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
I _{CBO}	collector-base cut-off current	I _E = 0; V _{CB} = -30 V	_	-50	nA
		I _E = 0; V _{CB} = -30 V; T _j = 150 °C	_	-10	μА
I _{EBO}	emitter-base cut-off current	I _C = 0; V _{EB} = -5 V	_	-50	nA
h _{FE}	DC current gain	V _{CE} = -1 V			
		$I_{C} = -0.1 \text{ mA}$	60	-	
		$I_C = -1 \text{ mA}$	80	_	
		$I_C = -10 \text{ mA}$	100	300	
		$I_C = -50$ mA; note 1	60	-	
		$I_{C} = -100 \text{ mA}$; note 1	30	_	
V _{CEsat}	collector-emitter saturation	$I_C = -10 \text{ mA}; I_B = -1 \text{ mA}$	_	-250	mV
	voltage	$I_C = -50 \text{ mA}$; $I_B = -5 \text{ mA}$; note 1	_	-400	mV
V _{BEsat}	base-emitter saturation voltage	$I_C = -10 \text{ mA}; I_B = -1 \text{ mA}$	_	-850	mV
		$I_C = -50 \text{ mA}$; $I_B = -5 \text{ mA}$; note 1	_	-950	mV
C _c	collector capacitance	$I_E = i_e = 0$; $V_{CB} = -5 \text{ V}$; $f = 1 \text{ MHz}$	_	4.5	pF
C _e	emitter capacitance	$I_C = i_c = 0$; $V_{EB} = -0.5 \text{ V}$; $f = 1 \text{ MHz}$	_	14	pF
f _T	transition frequency	$I_E = -10 \text{ mA}; V_{CB} = -20 \text{ V}; f = 100 \text{ MHz}$	150	Ī-	MHz
F	noise figure	I_C = -100 μA; V_{CE} = -5 V; R_S = 1 kΩ; f = 10 Hz to 15.7 kHz	_	4	dB
Switching t	imes (between 10% and 90% lev	rels); see Fig.1			
t _{on}	turn-on time	$I_{Con} = -10 \text{ mA}$; $I_{Bon} = -1 \text{ mA}$; $I_{Boff} = 1 \text{ mA}$	_	100	ns
t _d	delay time		_	50	ns
t _r	rise time		_	50	ns
t _{off}	turn-off time		_	700	ns
t _s	storage time		_	600	ns
t _f	fall time		_	100	ns

Note

1. Pulse test: $t_p \le 300~\mu s;~\delta \le 0.02.$

PNP switching transistor

PMSS3906



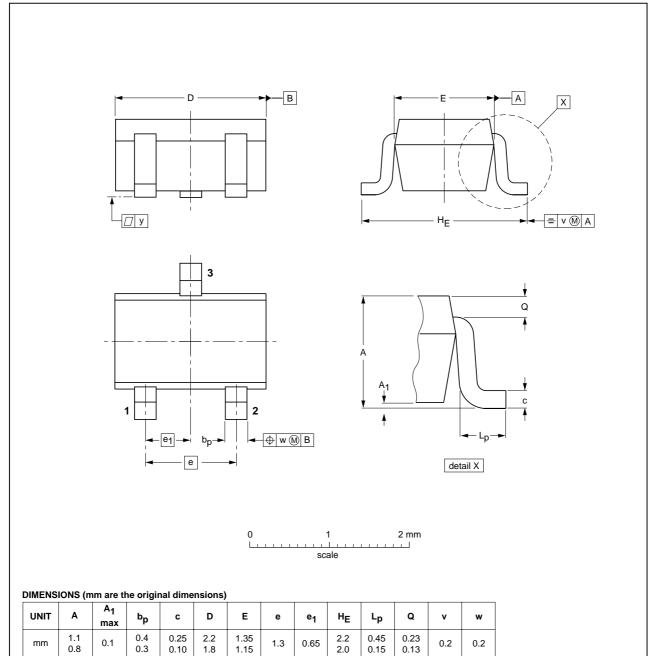
PNP switching transistor

PMSS3906

PACKAGE OUTLINE

Plastic surface-mounted package; 3 leads

SOT323



OUTLINE	REFERENCES			EUROPEAN	IOOUE DATE	
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
SOT323			SC-70			04-11-04 06-03-16

2004 Jan 09 6

0.3

PNP switching transistor

PMSS3906

DATA SHEET STATUS

DOCUMENT STATUS ⁽¹⁾	PRODUCT STATUS ⁽²⁾	DEFINITION
Objective data sheet	Development	This document contains data from the objective specification for product development.
Preliminary data sheet	Qualification	This document contains data from the preliminary specification.
Product data sheet	Production	This document contains the product specification.

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Customer notification

This data sheet was changed to reflect the new company name NXP Semiconductors, including new legal definitions and disclaimers. No changes were made to the technical content, except for package outline drawings which were updated to the latest version.

Contact information

For additional information please visit: http://www.nxp.com

For sales offices addresses send e-mail to: salesaddresses@nxp.com

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